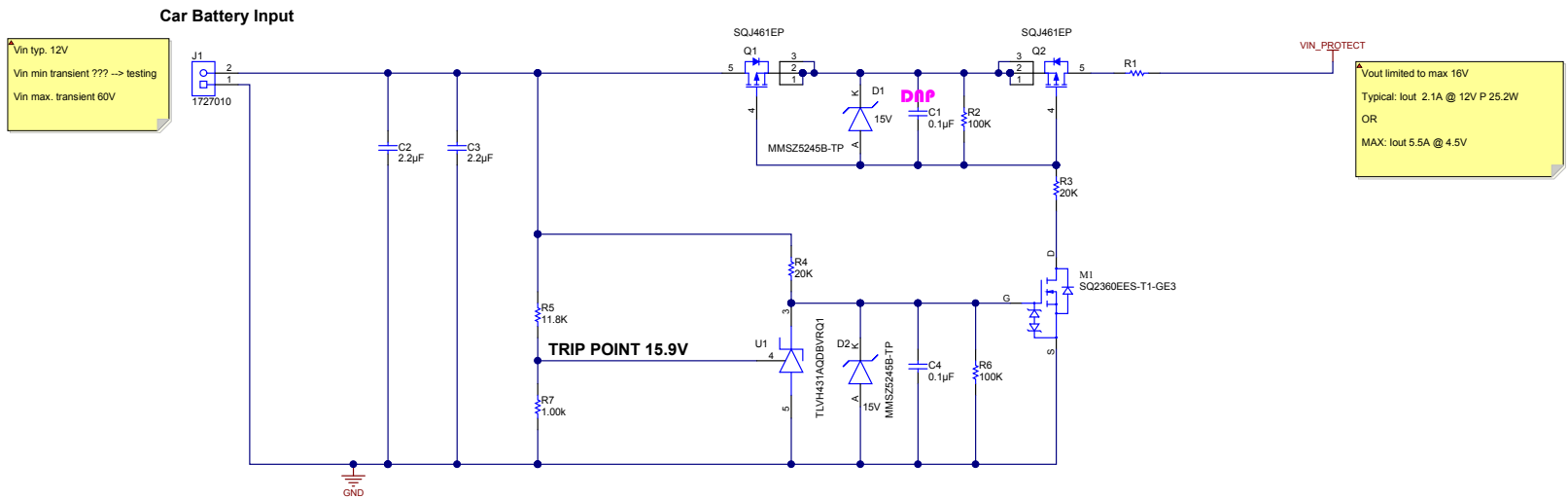

Designed for: Public Release	Mod. Date: 8/18/2014
Project Title: Remote Camera and Radar Expansion, SAT0074	
Number: TIDA-00271 Rev: E2	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted Sheet: 2 of 13
Drawn By:	File: protection.SchDoc Size: B
Engineer: Joern Oppenhaeuser	Contact: http://www.ti.com/support

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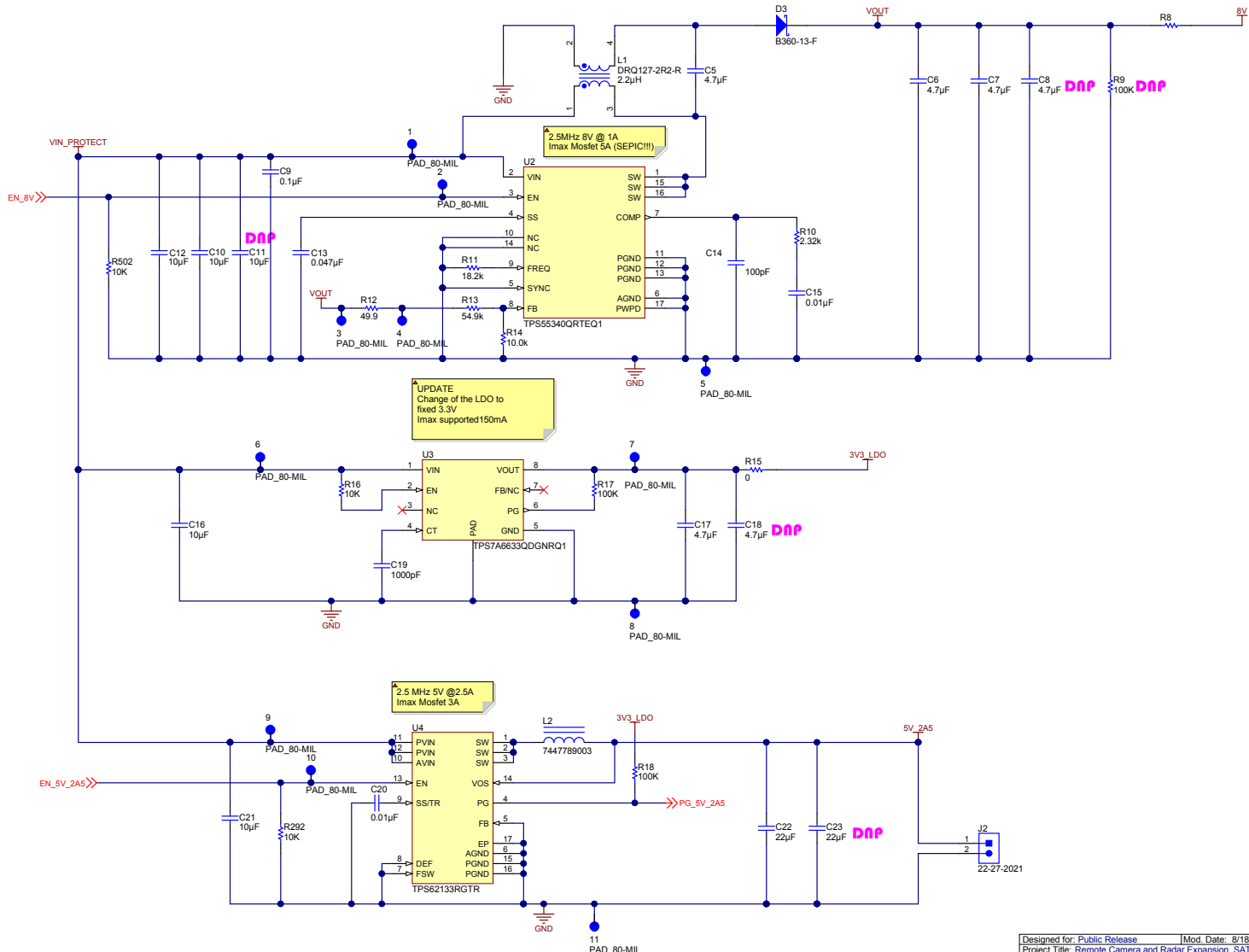

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Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 3 of 13
Drawn By:		File: Power_SEPIC.SchDoc	Size: B
Engineer: Joern Oppenhaeuser		Contact: http://www.ti.com/support	

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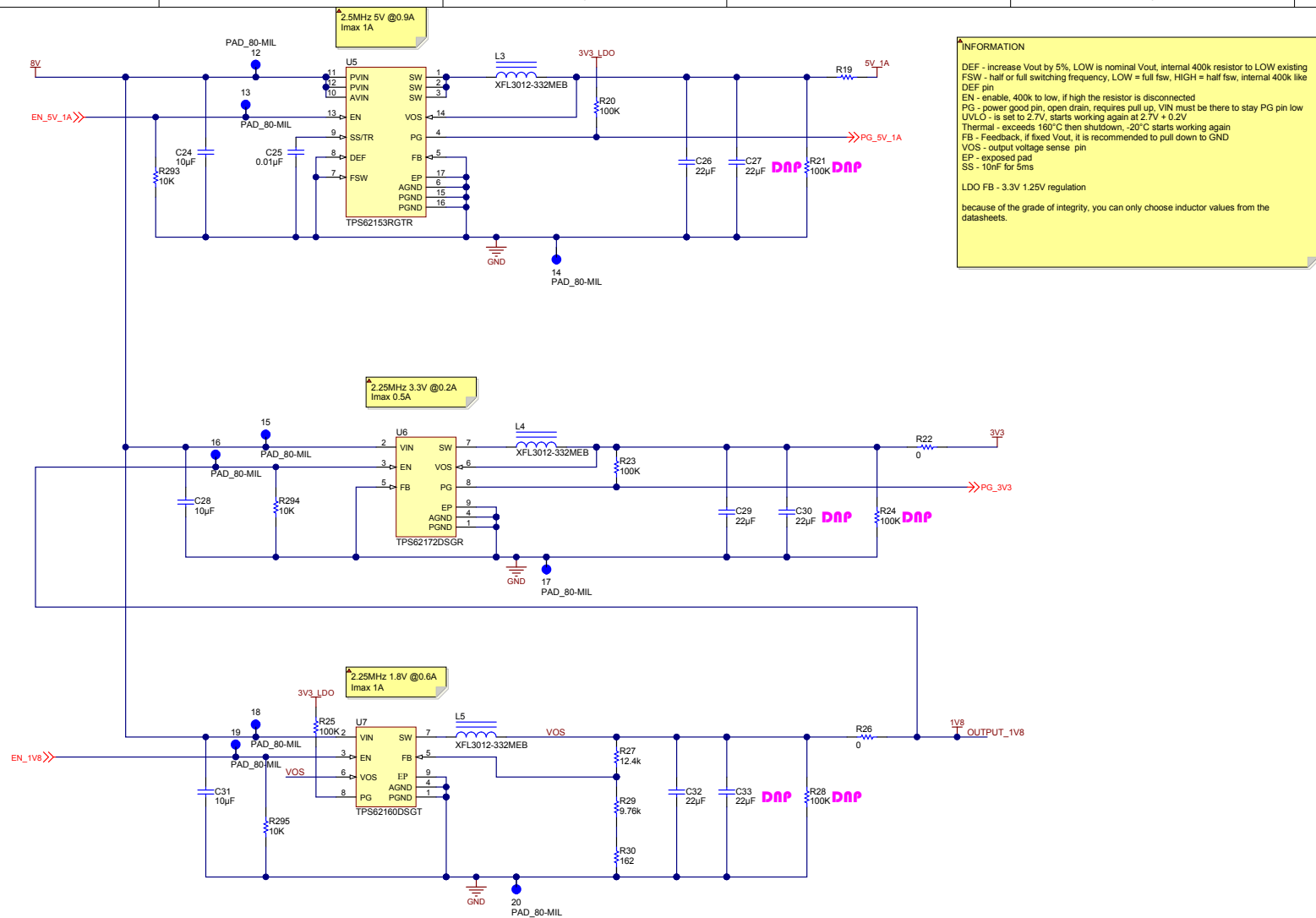

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Project Title: Remote Camera and Radar Expansion, SAT0074	
Number: TIDA-00271 Rev: E2	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted Sheet: 4 of 13
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Engineer: Joern Oppenhaeuser	Contact: http://www.ti.com/support

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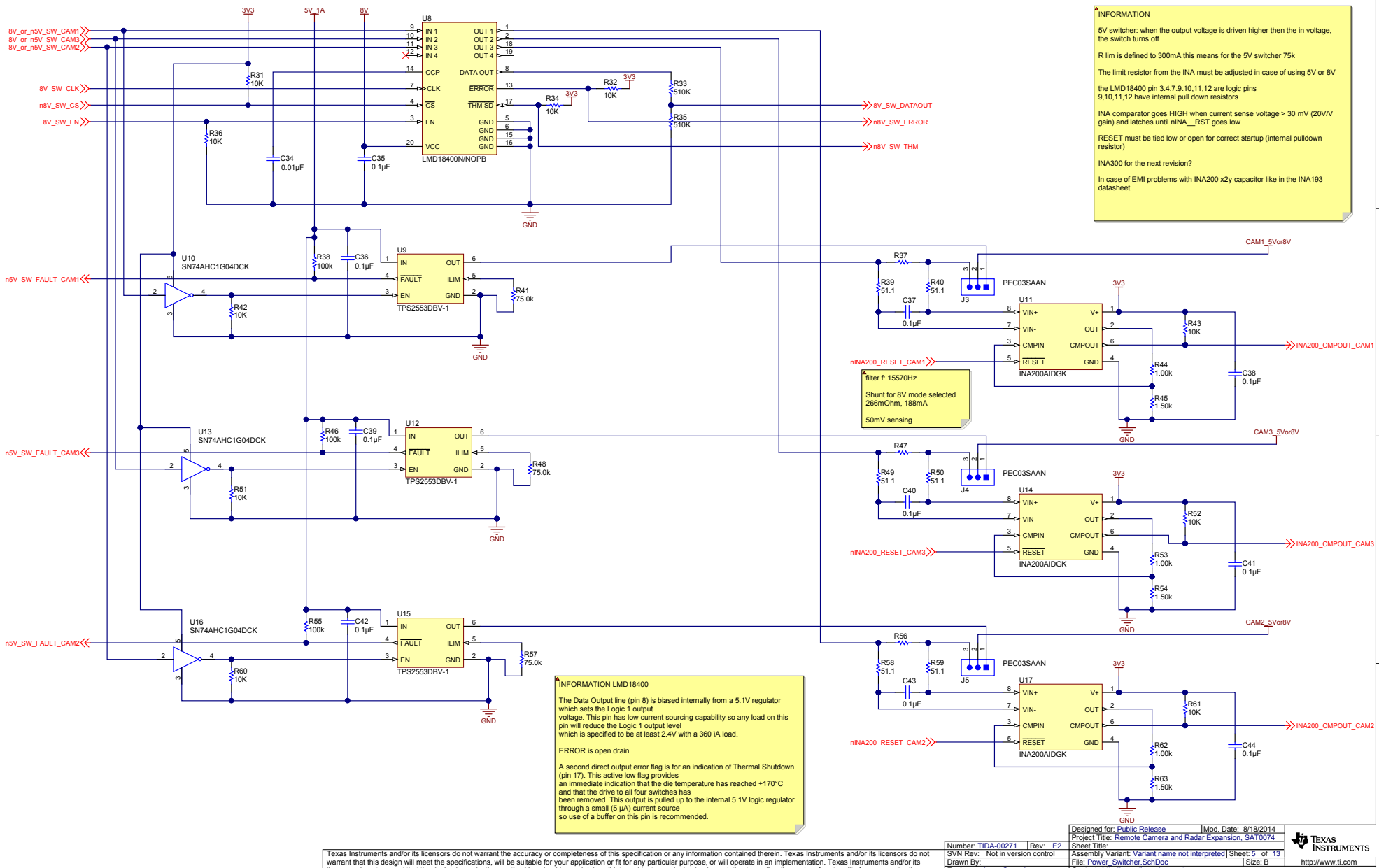

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Number: TIDA-00271	Rev: E2	Sheet Title:	
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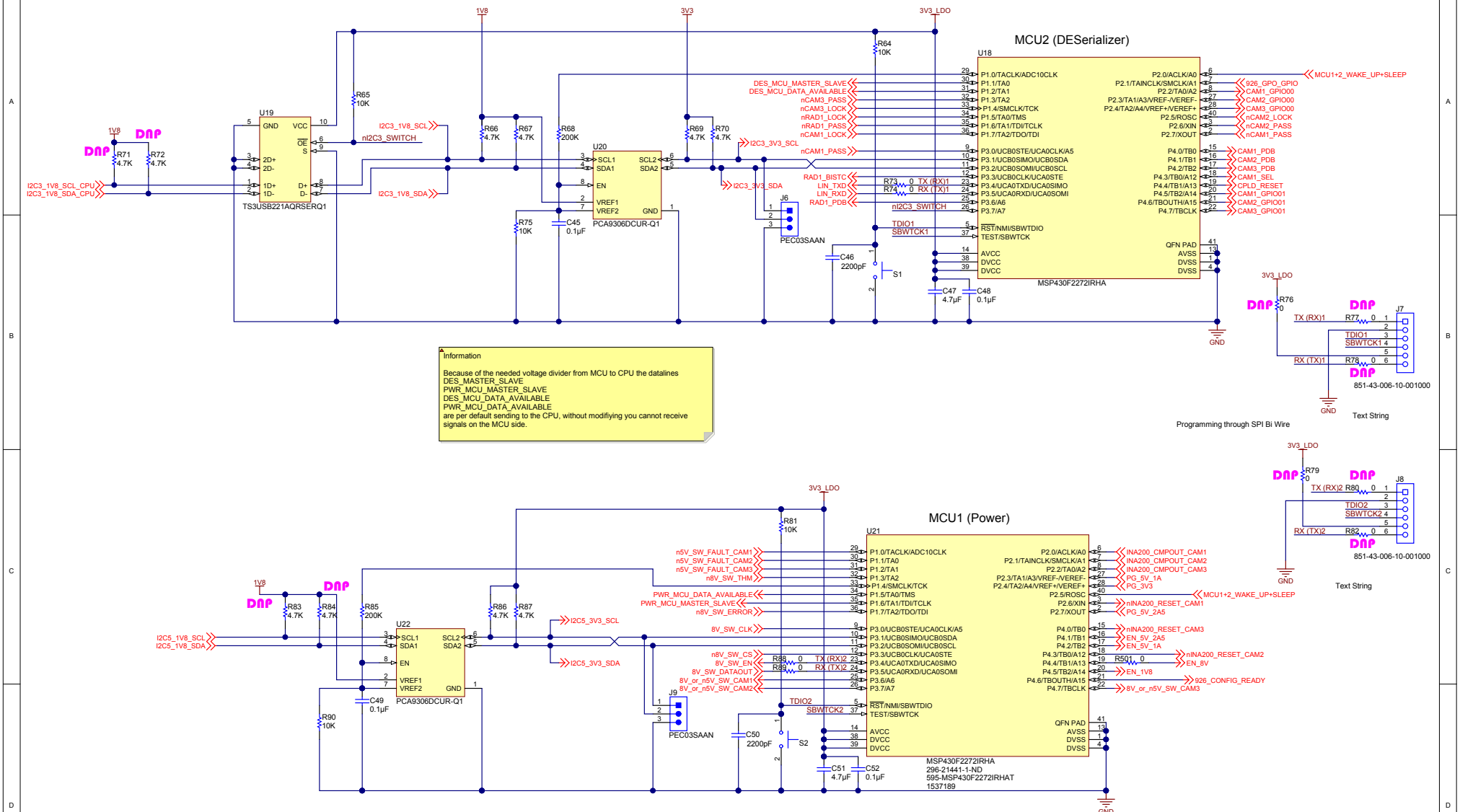

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Project Title: Remote Camera and Radar Expansion, SAT0074			
Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 6 of 13
Drawn By:		File: MCUs.SchDoc	Size: B
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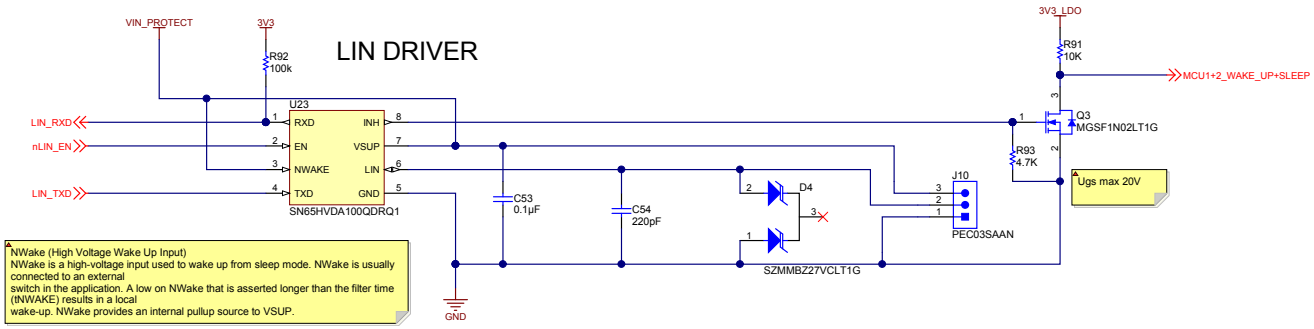
INFORMATION

LIN
TXD -- Transmit input/output
RXD - Receive Output
Vsup - Supply Voltage
EN - Enable input, internal pull down
NWAKE - high voltage input, to wake up from sleep
INHIBIT - switches Vsupply to the pin = 17V

TPIC
A0, A1, A2 are defining the I2C address via digital logic
G enables the device outputs

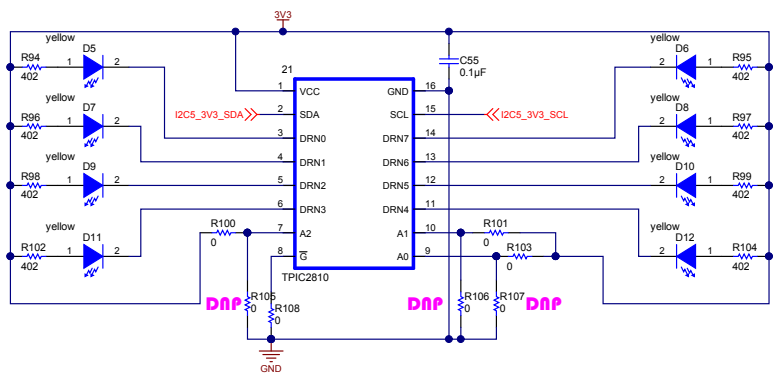
For the HVDA100, the RXD pin is an output, and the TXD pin is an input.

LIN DRIVER



NWake (High Voltage Wake Up Input)
NWake is a high-voltage input used to wake up from sleep mode. NWake is usually connected to an external
switch in the application. A low on NWake that is asserted longer than the filter time (tNWAKE) results in a local
wake-up. NWake provides an internal pullup source to VSUP.

LED DRIVER



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Drawn By:		Sheet Title:	
Engineer: Joern Oppenhaeuser		Assembly Variant: Variant name not interpreted	Sheet: 7 of 13
		File: LIN_LED.SchDoc	Size: B
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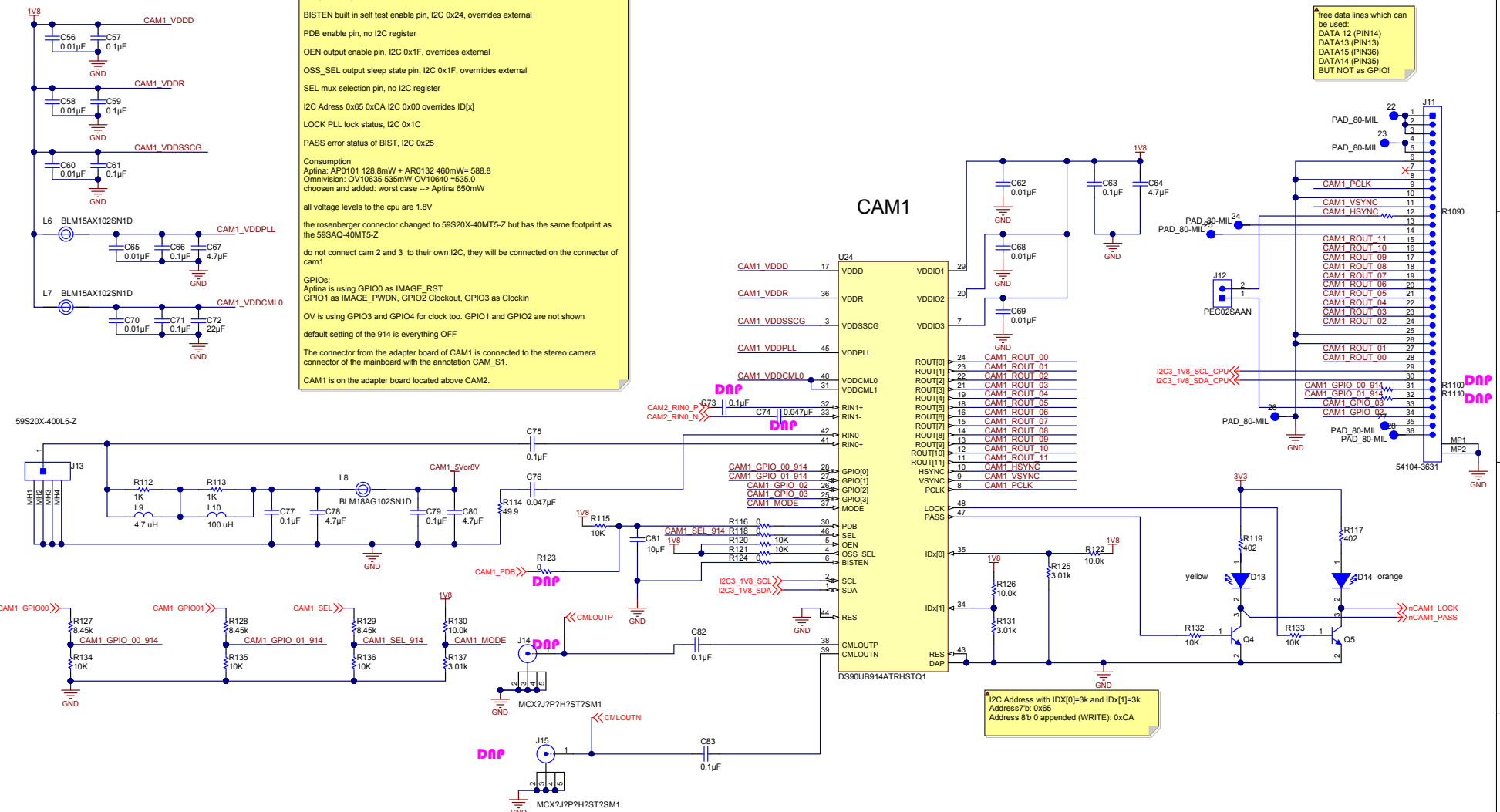

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Project Title: Remote Camera and Radar Expansion, SAT0074			
Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 8 of 13
Drawn By:		File: des914_cam1.SchDoc	Size: B
Engineer: Joern Oppenhaeuser		Contact: http://www.ti.com/support	

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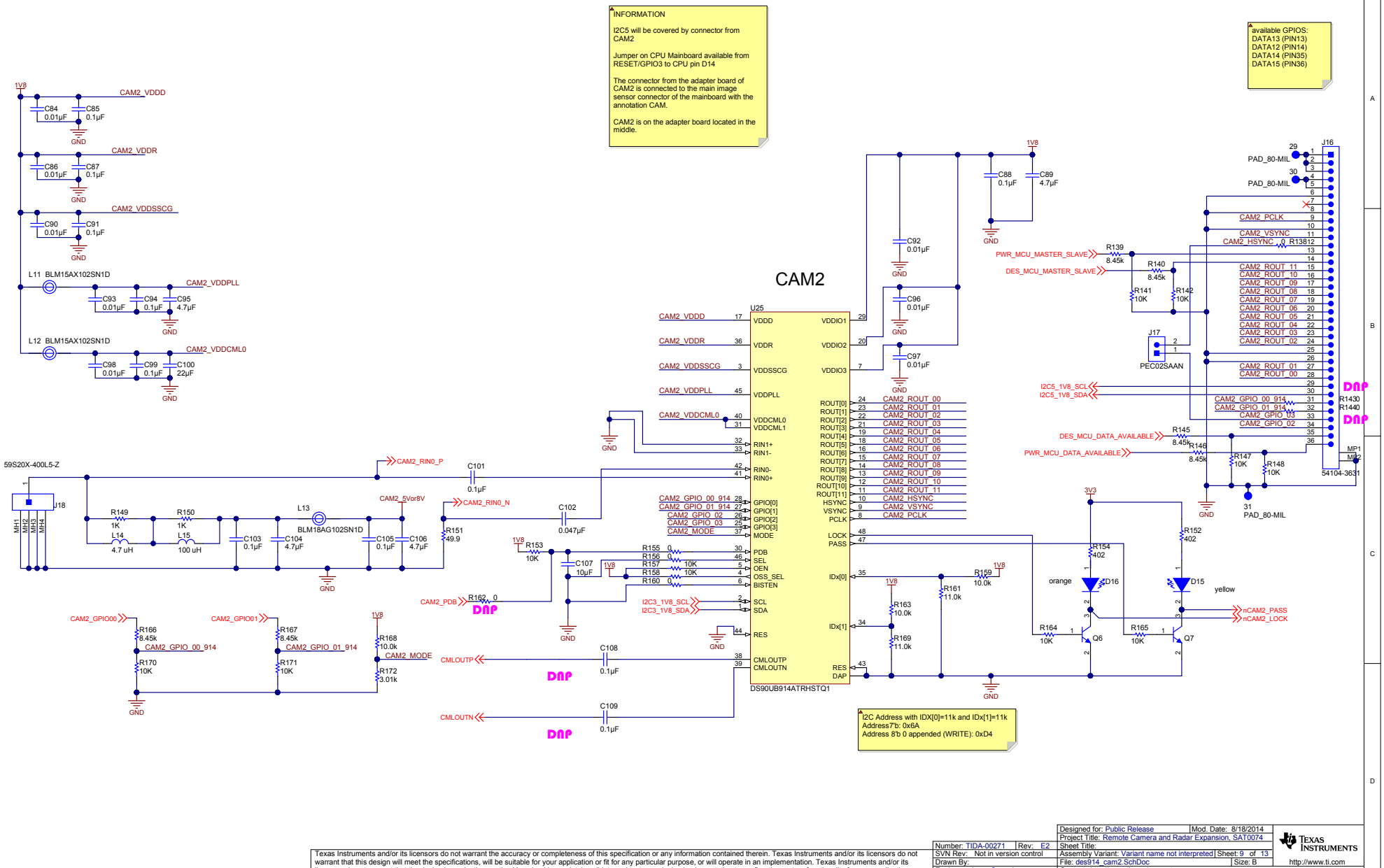
INFORMATION
I2C5 will be covered by connector from CAM2
Jumper on CPU Mainboard available from RESET/GPIO3 to CPU pin D14
The connector from the adapter board of CAM2 is connected to the main image sensor connector of the mainboard with the annotation CAM.
CAM2 is on the adapter board located in the middle.
available GPIOS:
DATA13 (PIN13)
DATA12 (PIN14)
DATA14 (PIN35)
DATA15 (PIN36)
CAM2
U25
DS90UB914ATRHSTQ1
J16
J17
PEC02SAAN
J18
59S20X-400L5-Z
54104-3631
I2C Address with IDX[0]=11k and IDx[1]=11k
Address7'b: 0x6A
Address 8'b 0 appended (WRITE): 0xD4
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Mod. Date: 8/18/2014
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Sheet Title:
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Rev: E2
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Assembly Variant: Variant name not interpreted
Sheet: 9 of 13
Drawn By:
File: des914_cam2.SchDoc
Size: B
Engineer: Joern Oppenhaeuser
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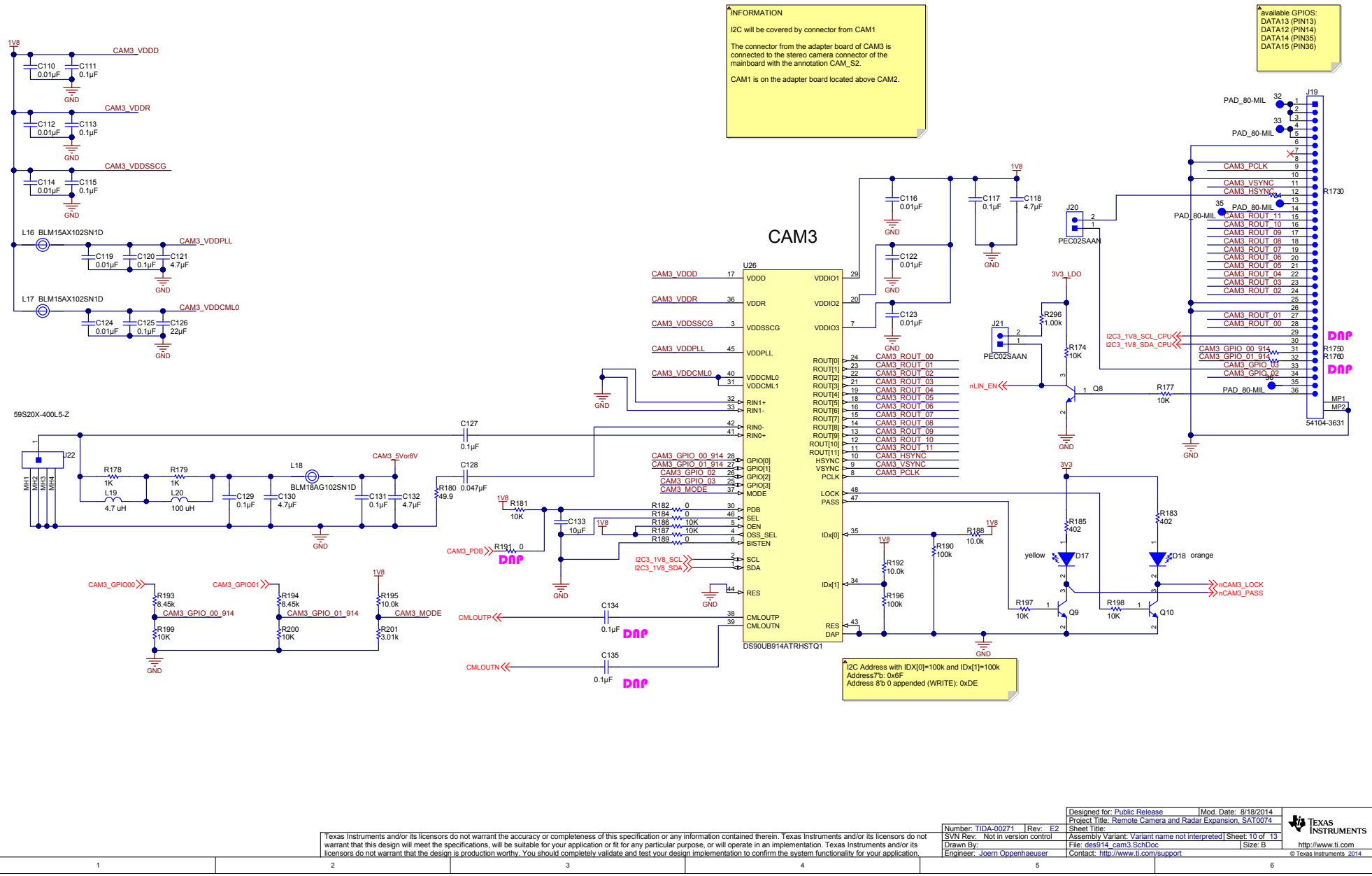

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Project Title: Remote Camera and Radar Expansion, SAT0074			
Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 10 of 13
Drawn By:		File: des914_cam3.SchDoc	Size: B
Engineer: Joern Oppenhaeuser		Contact: http://www.ti.com/support	

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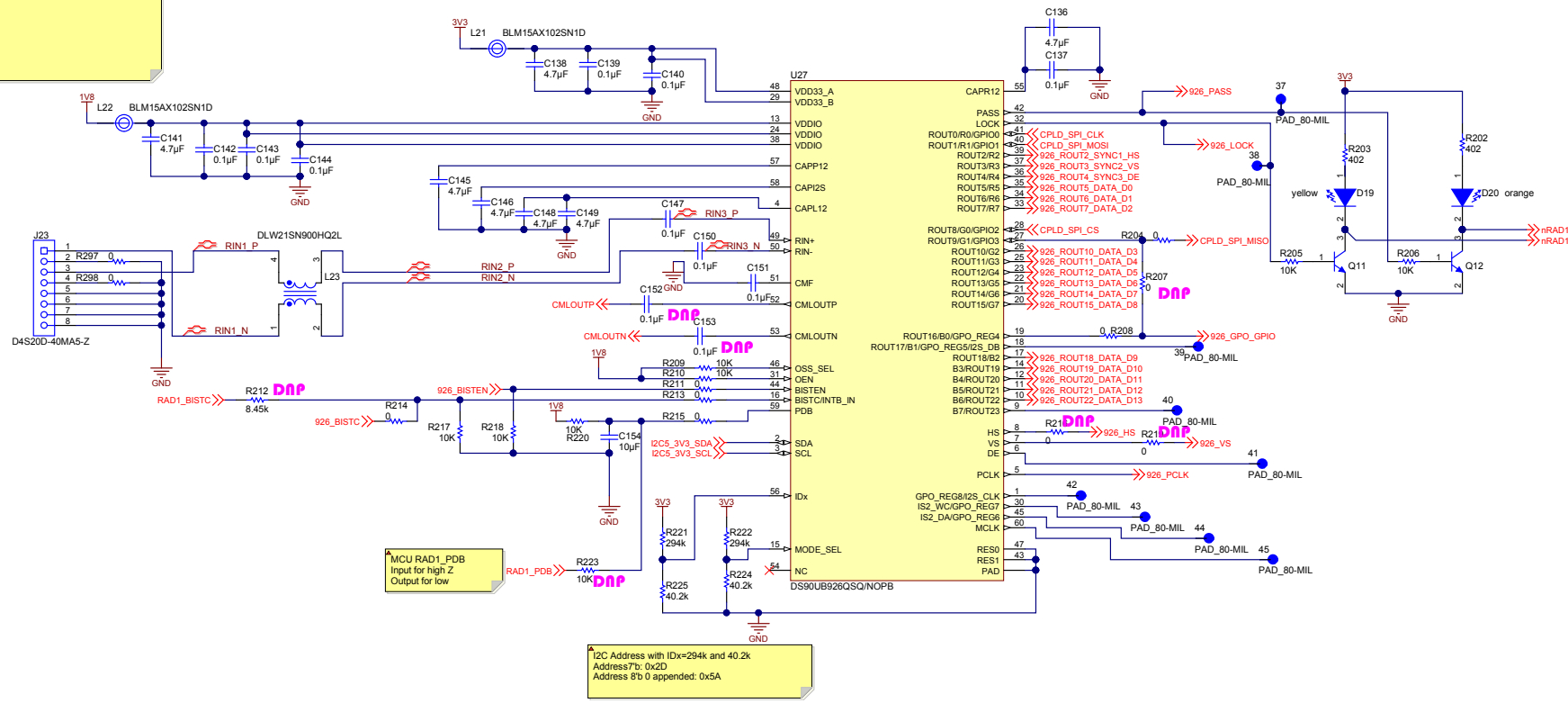

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Project Title: Remote Camera and Radar Expansion, SAT0074	
Number: TIDA-00271 | Rev: E2	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted | Sheet: 11 of 13
Drawn By:	File: RADAR_des926.SchDoc | Size: B
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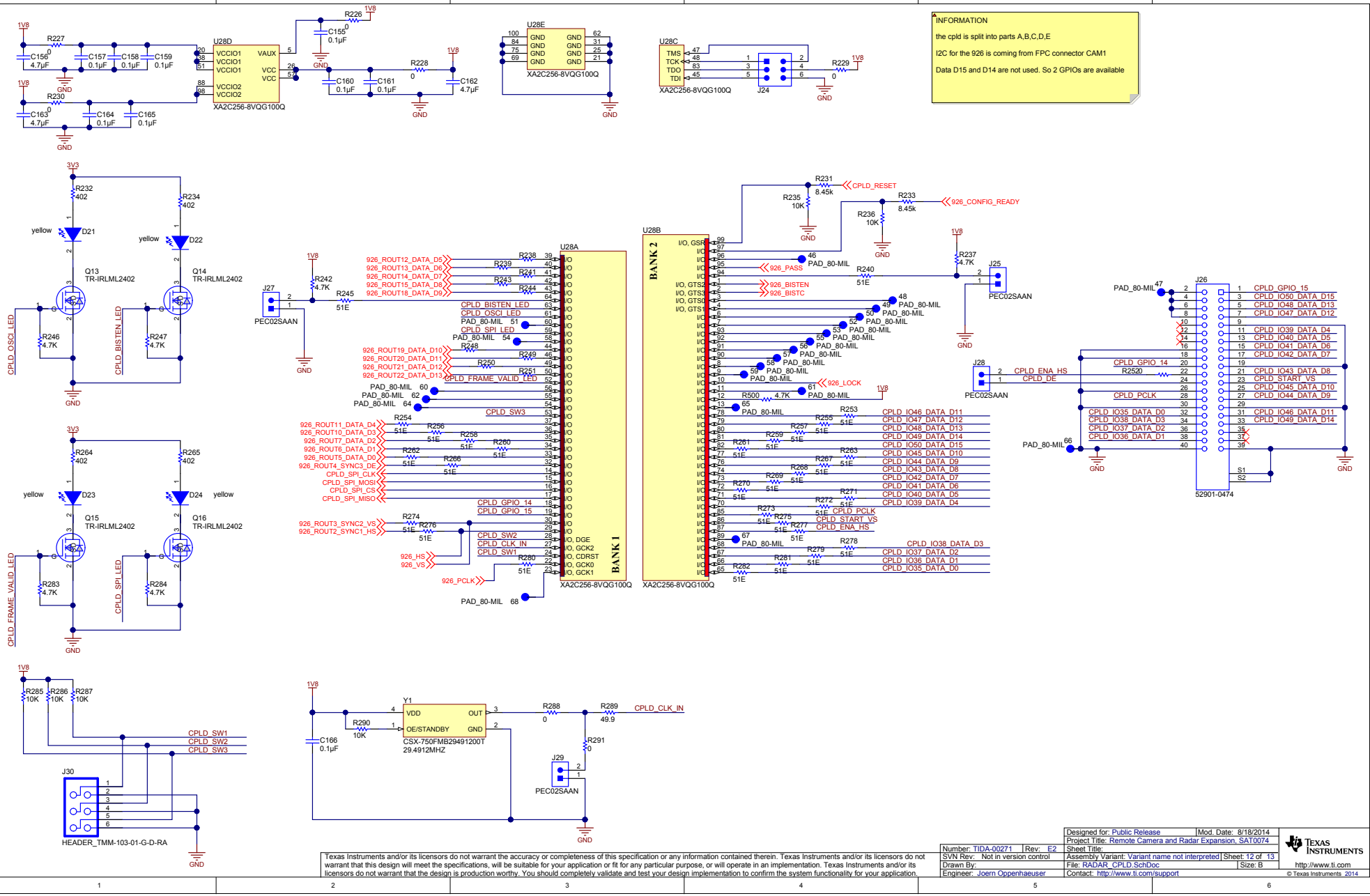

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Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 12 of 13
Drawn By:		File: RADAR_CPLD.SchDoc	Size: B
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PCB
LOGO
Texas Instruments

FID1 FID2 FID3

PCB Number: TIDA-00271
PCB Rev: E2

You should delete the nylon screws/standoffs and/or the bumpons as needed for your design (or substitute other parts from Hardware.IntLib). Bumpons are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: TIDA-00271	Rev: E2	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: Variant name not interpreted	Sheet: 13 of 13
Drawn By:		File: Hardware.SchDoc	Size: B
Engineer: Joern Oppenhaeuser		Contact: http://www.ti.com/support	

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